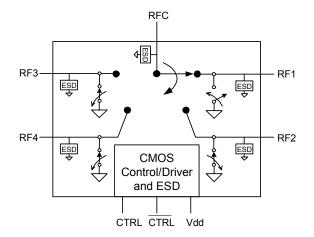


# **Product Description**

The PE42440 is a HaRP™-enhanced SP4T RF Switch developed on the UltraCMOS™ process technology. This general-purpose switch contains 4 identical RF ports and can be used in a multitude of applications up to 3000 MHz. It integrates on-board CMOS control logic with a low voltage CMOS-compatible control interface and requires no DC blocking capacitors. This RoHS-compliant part is available in a standard 3x3x0.75mm QFN package.

Peregrine's HaRP™ technology enhancements deliver high linearity and exceptional harmonics performance. It is an innovative feature of the UltraCMOS™ process, providing performance superior to GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Diagram



# **Product Specification** PE42440

## SP4T UltraCMOS™ RF Switch 50 - 3000 MHz

#### **Features**

- HaRP<sup>™</sup> enhanced Technology for Unparalleled Linearity
- Very Low Insertion Loss: 0.45 dB @ 1000 MHz, 0.5 dB @ 2000 MHz
- Very high isolation: 34 dB @ 1000 MHz, 28 dB @ 2000 MHz
- Exceptionally high ESD tolerance:
  - Class 3 (4.0 kV HBM) on RFC pin
  - Class 2 (2.0 kV HBM) on all pins
- Integrated decoder for 2-pin control
  - Accepts 1.8V and 2.75V control logic levels
- Low 4.5 ohm series ON resistance
- No blocking capacitors required

Figure 2. Package Type

16-lead 3x3 mm QFN





Table 1. Electrical Specifications: Temp = 25°C,  $V_{DD}$  = 2.75 V ( $Z_{S}$  =  $Z_{L}$  = 50  $\Omega$ )

Parameter	Condition	Min	Тур	Max	Units
Operational Frequency		50		3000	MHz
	50 MHz - 1000 MHz	-	0.45	0.65	dB
Insertion Loss (RFC - RFX)	1000 MHz - 2000 MHz	-	0.5	0.7	dB
	2000 MHz - 3000 MHz	-	0.85	1.15	dB
	50 MHz - 1000 MHz	-	22	-	dB
Return Loss (RFC - RFX, Active Ports)	1000 MHz - 2000 MHz	-	15	-	dB
	2000 MHz - 3000 MHz	-	11	-	dB
	50 MHz - 1000 MHz	31	34	-	dB
Isolation (RFC - RFX)	1000 MHz - 2000 MHz	25	28	-	dB
	2000 MHz - 3000 MHz	20	22	-	dB
Input IP2	50 - 3000 MHz, +18dBm per tone, 1MHz spacing		96		dBm
Input IP3	50 - 3000 MHz, +18dBm per tone, 1MHz spacing		67		dBm
P1dB <sup>1</sup>	50 - 3000 MHz		41.5		dBm
Switching time	50% CNTL to 10/90% of RF		2		μs

Note: 1. Please refer to Maximum Operating Pin (50 $\Omega$ ) in Table 4

Table 2. Electrical Specifications, Worst Case Conditions: Temp = 85°C,  $V_{DD}$  = 2.65 V ( $Z_{S}$  =  $Z_{L}$  = 50  $\Omega$ )

Parameter	Condition	Min	Тур	Max	Units
Operational Frequency		50		3000	MHz
	50 MHz - 1000 MHz	-	0.5	0.65	dB
Insertion Loss (RFC - RFX)	1000 MHz - 2000 MHz	-	0.65	0.75	dB
	2000 MHz - 3000 MHz	-	1.0	1.25	dB
	50 MHz - 1000 MHz	-	21	-	dB
Return Loss (RFC - RFX, Active Ports)	1000 MHz - 2000 MHz	-	15	-	dB
	2000 MHz - 3000 MHz	-	10	-	dB
	50 MHz - 1000 MHz	30	32	-	dB
Isolation (RFC - RFX)	1000 MHz - 2000 MHz	24	26	-	dB
	2000 MHz - 3000 MHz	20	22	-	dB
Input IP2	50 - 3000 MHz, +18dBm per tone, 1MHz spacing		95		dBm
Input IP3	50 - 3000 MHz, +18dBm per tone, 1MHz spacing		66		dBm
P1dB <sup>2</sup>	50 - 3000 MHz		41		dBm
Switching time	50% CNTL to 10/90% of RF		2		μs

Note: 2. Please refer to Maximum Operating Pin  $(50\Omega)$  in Table 4



Figure 3. Pin Configuration (Top View)

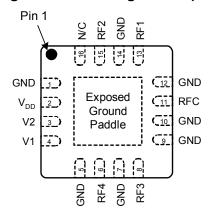


Table 3. Pin Descriptions

Pin No.	Pin Name	Description
1	GND	Ground
2	$V_{DD}$	Supply
3	V2	Switch control input, CMOS logic level
4	V1	Switch control input, CMOS logic level
5	GND	Ground
6	RF4 <sup>3</sup>	RF Port 4
7	GND	Ground
8	RF3 <sup>3</sup>	RF Port 3
9	GND	Ground
10	GND	Ground
11	RFC <sup>3</sup>	RF Common
12	GND	Ground
13	RF1 <sup>3</sup>	RF Port 1
14	GND	Ground
15	RF2 <sup>3</sup>	RF Port 2
16	N/C	No Connect
Paddle	GND	Exposed ground paddle

Note: 3. All RF pins must be DC blocked with an external series capacitor or held at 0 V<sub>DC</sub>.

Table 4. Operating Ranges

Parameter	Symbol	Min	Тур	Max	Units
V <sub>DD</sub> Supply Voltage	$V_{DD}$	2.65	2.75	3.3	V
$I_{DD}$ Power Supply Current $(V_{DD} = 2.75 \text{ V})$	I <sub>DD</sub>		13	50	μΑ
RF input power (50 Ω) (50-500 MHz) (500-3000 MHz)	P <sub>IN</sub>			+28 +33	dBm dBm
Control Voltage High	V <sub>IH</sub>	1.4			V
Control Voltage Low	V <sub>IL</sub>			0.4	V
Temperature range	T <sub>OP</sub>	-40	+25	+85	°C
Storage Temperature Range	T <sub>ST</sub>	-65	+25	+160	°C

**Table 5. Absolute Maximum Ratings** 

Symbol	Parameter/Conditions	Min	Max	Units
$V_{DD}$	Power supply voltage	-0.3	4.0	V
Vı	Voltage on any DC input	-0.3	V <sub>DD</sub> + 0.3	V
Ριν(50 Ω) <sup>4</sup>	RF input power (50-500 MHz) (500-3000 MHz)		+28 +33	dBm dBm
	HBM⁵ ESD Voltage, RFC pin		4000	V
$V_{ESD}$	HBM⁵ ESD Voltage, all pins		2000	٧
	MM ESD Voltage, RFC pin		300	٧
	MM ESD Voltage, all pins		100	V

Note: 4. V<sub>DD</sub> within operating range specified in Table 3.

5. ESD Voltage (HBM, MIL-STD-883 Method 3015.7)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

**Table 6. Truth Table** 

Path	V2	V1
RFC – RF1	0	0
RFC – RF2	1	0
RFC – RF3	0	1
RFC – RF4	1	1

# **Electrostatic Discharge (ESD) Precautions**

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESDsensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

## **Latch-Up Avoidance**

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

# **Moisture Sensitivity Level**

The Moisture Sensitivity Level rating for the PE42440 in the 16-lead 3x3 QFN package is MSL1.

## **Switching Frequency**

The PE42440 has a maximum 25 kHz switching rate.



## **Evaluation Kit**

The SP4T switch EK Board was designed to ease customer evaluation of Peregrine's PE42440. The RF common port is connected through a 50  $\Omega$ transmission line via the top SMA connector, J1. RF1, RF2, RF3 and RF4 are connected through 50  $\Omega$  transmission lines via SMA connectors J3, J5, J2 and J4, respectively. A through 50  $\Omega$ transmission is available via SMA connectors J6 and J7. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a four metal layer FR4 material with a total thickness of 62 mils. The middle layers provide ground for the transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 32 mils, trace gaps of 25 mils, and metal thickness of 2.1 mils.

Figure 4. Evaluation Board Layouts

Peregrine Specification 101/0287

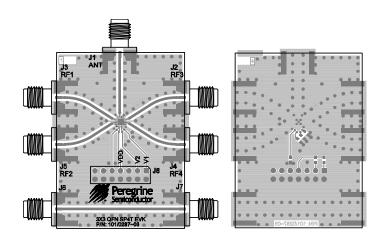


Figure 5. Evaluation Board Schematic

Peregrine Specification 102/0339

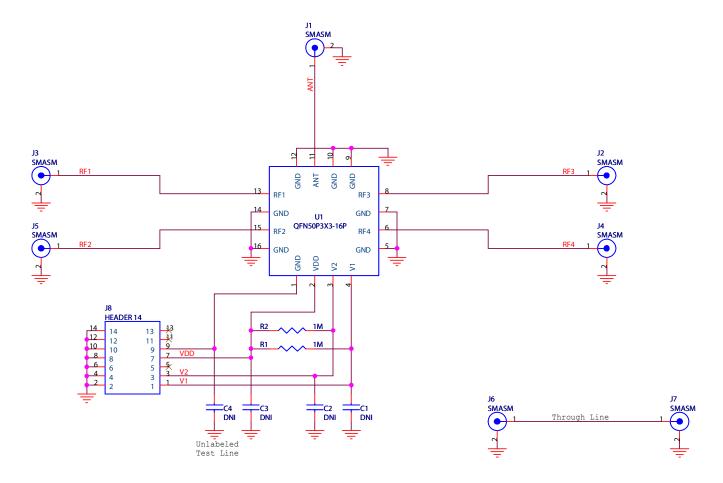




Figure 6. Insertion Loss: RFC-RF @ 25 °C

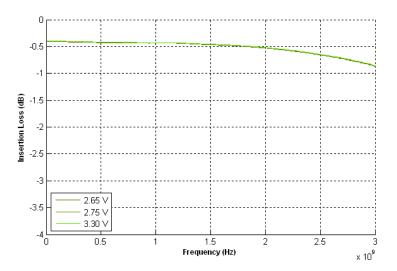


Figure 7. Insertion Loss: RFC-RF @ 2.75 V

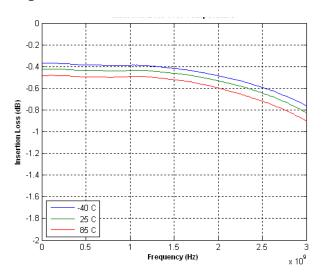


Figure 8. Isolation: RFC-RF @ 25 °C

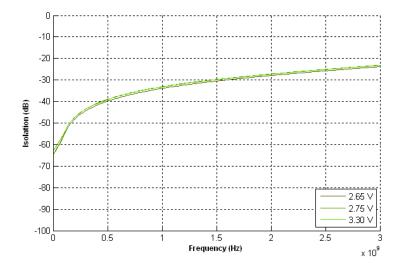


Figure 9. Isolation: RFC-RF @ 2.75 V

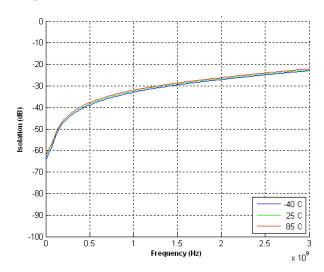


Figure 10. Return Loss at active port @ 25 °C

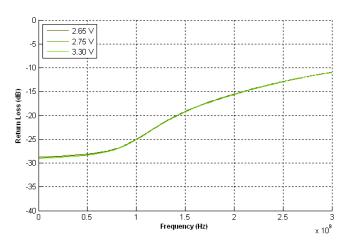
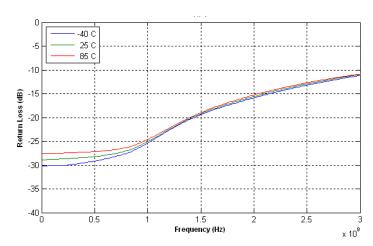


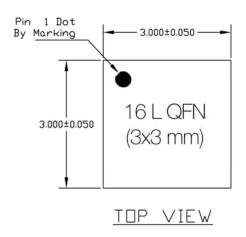
Figure 11. Return Loss at active port @ 2.75 V

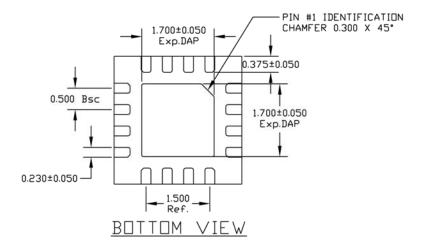




# Figure 12. Package Drawing

16-lead 3x3mm QFN: 19-0128-01





		QFN 3x3 mm
	MAX	0.800
Α	NOM	0.750
	MIN	0.700

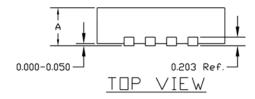
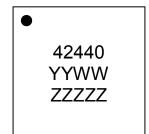


Figure 13. Marking Specifications

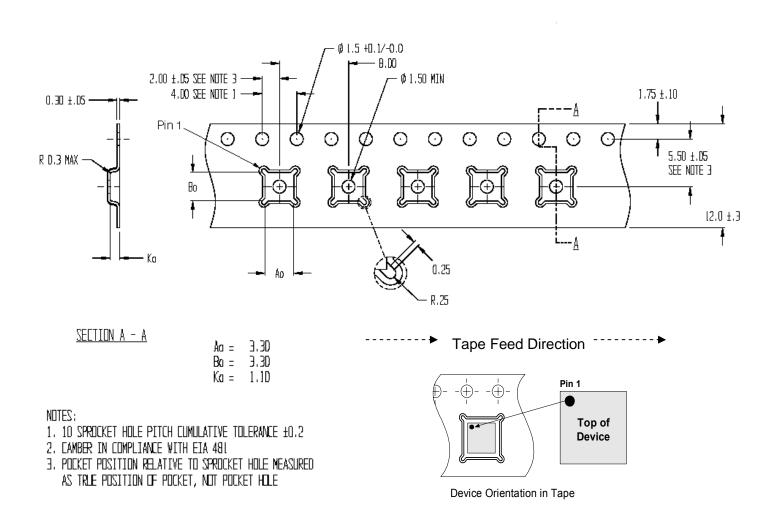


YYWW = Date Code ZZZZZ = Last five digits of Lot Number



# Figure 14. Tape and Reel Specifications

16-lead 3x3 mm QFN



**Table 7. Ordering Information** 

Order Code	Part Marking	Description	Description Package	
PE42440MLIBA	42440	PE42440G-16QFN 3x3mm-loose or cut tape	Green 16-lead 3x3mm QFN	Loose or cut tape
PE42440MLIBA-Z	42440	PE42440G-16QFN 3x3mm-3000C	Green 16-lead 3x3mm QFN	3000 units / T&R
EK42440-01	PE42440-EK	PE42440-16QFN 3x3mm-EK	Evaluation Kit	1 / Box



# Sales Offices

#### The Americas

#### **Peregrine Semiconductor Corporation**

9380 Carroll Park Drive San Diego, CA 92121 Tel: 858-731-9400 Fax: 858-731-9499

## Europe

# **Peregrine Semiconductor Europe**

Bâtiment Maine 13-15 rue des Quatre Vents F-92380 Garches, France Tel: +33-1-4741-9173

Fax: +33-1-4741-9173

## **High-Reliability and Defense Products**

Americas San Diego, CA, USA Phone: 858-731-9475 Fax: 848-731-9499

Europe/Asia-Pacific Aix-En-Provence Cedex 3. France

Phone: +33-4-4239-3361 Fax: +33-4-4239-7227

# Peregrine Semiconductor, Asia Pacific (APAC)

Shanghai, 200040, P.R. China Tel: +86-21-5836-8276 Fax: +86-21-5836-7652

#### Peregrine Semiconductor, Korea

#B-2607, Kolon Tripolis, 210 Geumaok-dong, Bundang-au, Seongnam-si Gyeonggi-do, 463-943 South Korea Tel: +82-31-728-3939

Fax: +82-31-728-3940

#### Peregrine Semiconductor K.K., Japan

Teikoku Hotel Tower 10B-6 1-1-1 Uchisaiwai-cho, Chiyoda-ku Tokyo 100-0011 Japan

Tel: +81-3-3502-5211 Fax: +81-3-3502-5213

For a list of representatives in your area, please refer to our Web site at: www.psemi.com

#### **Data Sheet Identification**

#### Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

#### Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

# **Product Specification**

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer Notification Form).

The information in this data sheet is believed to be reliable. However, Peregrine assumes no liability for the use of this information. Use shall be entirely at the user's own risk.

No patent rights or licenses to any circuits described in this data sheet are implied or granted to any third party.

Peregrine's products are not designed or intended for use in devices or systems intended for surgical implant, or in other applications intended to support or sustain life, or in any application in which the failure of the Peregrine product could create a situation in which personal injury or death might occur. Peregrine assumes no liability for damages, including consequential or incidental damages, arising out of the use of its products in such applications.

The Peregrine name, logo, and UTSi are registered trademarks and UltraCMOS, HaRP, MultiSwitch and DuNE are trademarks of Peregrine Semiconductor Corp.